

MAXIMUM RATINGS

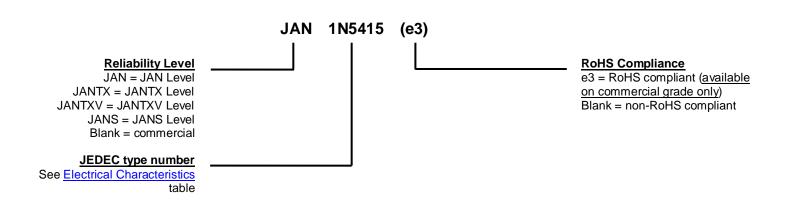
Notes: 1. At 3/8 inch (10 mm) lead length from body.

- 2. Derate linearly at 22 mA/°C for 55 °C \leq T_A \leq 100 °C.
- 3. Above $T_A = 100$ °C, derate linearly at 26.7 mA/°C to zero at $T_A = 175$ °C.
- These ambient ratings are for PC boards where thermal resistance from mounting point to ambient is sufficiently controlled where T_{J(max)} does not exceed 175 °C.
- 5. $I_F = 0.5 \text{ A}$, $I_{RM} = 1 \text{ A}$, $I_{R(REC)} = 0.250 \text{ A}$.

MECHANICAL and PACKAGING

- CASE: Hermetically sealed voidless hard glass with tungsten slugs.
- TERMINALS: Axial-leads are tin/lead (Sn/Pb) over copper. RoHS compliant matte-tin is available for commercial grade only.
- MARKING: Body paint and part number.
- POLARITY: Cathode band.
- TAPE & REEL option: Standard per EIA-296. Contact factory for quantities.
- WEIGHT: 750 milligrams.
- See Package Dimensions on last page.

PART NOMENCLATURE



SYMBOLS & DEFINITIONS							
Symbol	Definition						
V_{BR}	Minimum Breakdown Voltage: The minimum voltage the device will exhibit at a specified current.						
V_{RWM}	Working Peak Reverse Voltage: The maximum peak voltage that can be applied over the operating temperature range excluding all transient voltages (ref JESD282-B).						
Io	Average Rectified Output Current: The Output Current averaged over a full cycle with a 50 Hz or 60 Hz sine-wave input and a 180 degree conduction angle.						
V_{F}	Maximum Forward Voltage: The maximum forward voltage the device will exhibit at a specified current.						
I _R	Maximum Reverse Current: The maximum reverse (leakage) current that will flow at the specified voltage and temperature.						
t _{rr}	Reverse Recovery Time: The time interval between the instant the current passes through zero when changing from the forward direction to the reverse direction and a specified decay point after a peak reverse current occurs.						



ELECTRICAL CHARACTERISTICS

TYPE	MINIMUM BREAKDOWN VOLTAGE V _{BR} @ 50 μA Volts	FORWARD VOLTAGE V _F @ 9 A		MAXIMUM REVERSE CURRENT I _R @ V _{RWM}		CAPACITANCE C V _R @ 4 V
		MIN. Volts	MAX. Volts	25 °C μΑ	100 °C μΑ	pF
1N5415	55	0.6	1.5	1.0	20	550
1N5416	110	0.6	1.5	1.0	20	430
1N5417	220	0.6	1.5	1.0	20	250
1N5418	440	0.6	1.5	1.0	20	165
1N5419	550	0.6	1.5	1.0	20	140
1N5420	660	0.6	1.5	1.0	20	120

NOTE 1: $I_F = 0.5 \text{ A}$, $I_{RM} = 1 \text{ A}$, $I_{R(REC)} = 0.250 \text{ A}$.



GRAPHS

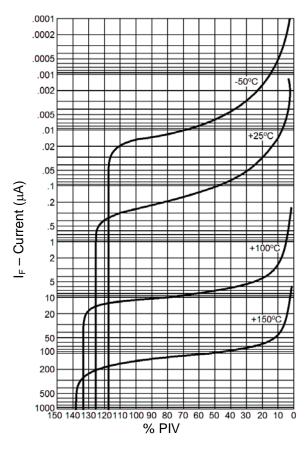


FIGURE 1
Typical Reverse Current vs. PIV

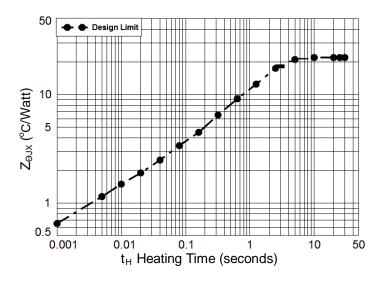


FIGURE 2

Maximum Thermal Impedance

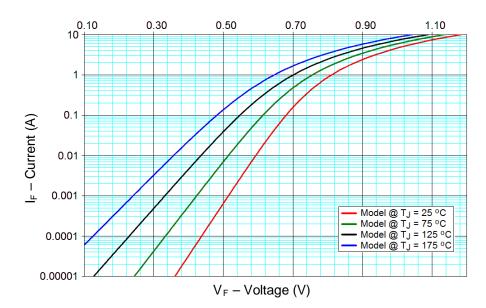
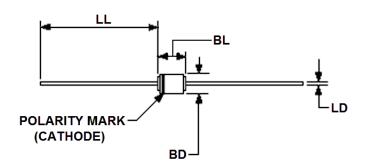


FIGURE 3
Typical Forward Current vs. Forward Voltage



PACKAGE DIMENSIONS



Symbol	Inch		Millir	Notes	
	Min	Max	Min	Max	
BD	0.110	0.180	2.79	4.57	3
LD	0.036	0.042	0.91	1.07	4
BL	0.130	0.260	3.30	6.60	4
LL	0.90	1.30	22.9	33.0	

NOTES:

- 1. Dimensions are in inches.
- 2. Millimeter equivalents are given for general information only.
- 3. Dimension BD shall be measured at the largest diameter.
- 4. The BL dimension shall include the entire body including slugs and sections of the lead over which the diameter is uncontrolled. This uncontrolled area is defined as the zone between the edge of the diode body and extending .050 inch (1.27 mm) onto the leads.
- 5. In accordance with ASME Y14.5M, diameters are equivalent to Φx symbology.